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## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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In re application of: Adrian E. Ong  
 Title: Layout And Use Of Bond Pads And Probe Pads For Testing Of Integrated Circuits Devices  
 Application No.: 10/003,375  
 Filing Date: November 15, 2001  
 Examiner: Tung X. Nguyen  
 Group Art Unit:: 2829  
 Confirmation No.: 4697  
 Law Office: Sidley Austin Brown & Wood LLP  
 Commissioner for Patents  
 P.O. Box 1450  
 Alexandria, VA 22313-1450

Dear Sir:

Pursuant to 37 C.F.R. § 1.56, § 1.97 and § 1.98, Applicant wishes to call the following documents (copies enclosed) to the attention of the Examiner for the above-identified patent application.

A form PTO-1449 listing these documents is enclosed.

Citation of the above documents shall not be construed as:

1. an admission that the documents are necessarily prior art with respect to the instant invention;
2. a representation that a search has been made; or

3. an admission that the information listed herein is, or is considered to be, material to patentability as defined in § 1.56(b).

**EXPRESS MAIL LABEL NO.:**

**EV 305 256 638 US**

Respectfully submitted,

By: 

Philip W. Woo  
Attorney of Record  
Reg. No. 39,880  
PWW/rp

July 3, 2003  
SIDLEY AUSTIN BROWN & WOOD LLP  
555 California Street, Suite 5000  
San Francisco, CA 94104-1715



U.S. Department of Commerce, Patent and Trademark Office				Atty Docket No.	Application No.		
				24295/81051	10/003,375		
INFORMATION DISCLOSURE STATEMENT BY APPLICANT				Applicant: Adrian E. Ong			
(Use several sheets if necessary)				Filing Date		Group	
				11/15/2001		2829	
<b>U.S. Patent Documents</b>							
*Examiner Initial		Document Number	Date	Name	Class	Subclass	Filing Date If
	1.	5,326,428	Jul. 5, 1994	Farnworth et al.			
	2.	5,457,400	Oct. 10, 1995	Ahmad et al.			
	3.	5,479,105	Dec. 26, 1995	Kim et al.			
	4.	5,523,697	Jun. 4, 1996	Farnworth et al.			
	5.	5,619,461	Apr. 8, 1997	Roohparvar			
	6.	5,657,284	Aug. 12, 1997	Beffa			
	7.	5,677,885	Oct. 14, 1997	Roohparvar			
	8.	5,751,015	May 12, 1998	Corbett et al.			
	9.	5,751,987	May 12, 1998	Mahant-Shetti et al.			
	10.	5,801,452	Sep. 1, 1998	Farnworth et al.			
	11.	5,805,609	Sep. 8, 1998	Mote, Jr.			
	12.	5,807,762	Spe. 15, 1998	Akram et al.			
	13.	5,825,697	Oct. 20, 1998	Gilliam et al.			
	14.	5,825,782	Oct. 20, 1998	Roohparvar			
	15.	5,923,600	Jul. 13, 1999	Momohara			
	16.	5,925,142	Jul. 20, 1999	Raad et al.			
	17.	5,936,260	Aug. 10, 1999	Corbett et al.			
	18.	5,959,310	Sep. 28, 1999	Akram et al.			
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	20.	6,026,039	Feb. 15, 2000	Kim et al.			
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	24.	6,137,167	Oct. 24, 2000	Ahn et al.			
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	26.	6,157,046	Dec. 5, 2000	Corbett et al.			
	27.	6,188,232 B1	Feb. 13, 2001	Akram et al.			
Examiner Signature:				Date Considered			
<p>*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with your communication to applicant.</p>							

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Sheet 2 of 2

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				24295/81051	10/003,375	
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(Use several sheets if necessary)				Filing Date		Group
				11/15/2001		2829
<b>U.S. Patent Documents</b>						
28.	6,194,738 B1	Feb. 27, 2001	Debenham et al.			
29.	6,208,157 B1	Mar. 27, 2001	Akram et al.			
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50.	6,484,279 B2	Nov. 19, 2002	Akram			
51.	6,502,215 B2	Dec. 31, 2002	Raad et al.			
52.	6,507,885 B2	Jan. 14, 2003	Lakhani et al.			
53.	6,519,725 B1	Feb. 11, 2003	Huisman et al.			
Examiner Signature:				Date Considered:		
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